

## **MOSFET**

### OptiMOS<sup>™</sup>5 Power-Transistor, 100 V

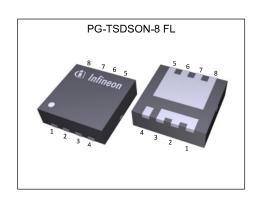
#### **Features**

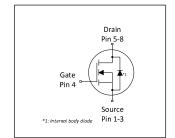
- Ideal for high frequency switching
  Optimized technology for DC/DC converters
  Excellent gate charge x R<sub>DS(on)</sub> product (FOM)
  N-channel, normal level
  100% avalanche tested

- Pb-free plating; RoHS compliant
  Qualified according to JEDEC<sup>1)</sup> for target applications
  Halogen-free according to IEC61249-2-21



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Parameter	Value	Unit				
$V_{ extsf{DS}}$	100	V				
R <sub>DS(on),max</sub>	9.7	mΩ				
ID	62	A				











Type / Ordering Code	Package	Marking	Related Links
BSZ097N10NS5	PG-TSDSON-8 FL	097N10N	-



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# 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 **Maximum ratings** 

<b>D</b>	0	Values			11!4	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	-	- - -	62 39 11	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =60 K/W <sup>2)</sup>
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	248	Α	T <sub>C</sub> =25 °C
Avalanche energy, single pulse <sup>4)</sup>	E <sub>AS</sub>	-	-	97	mJ	$I_D$ =20 A, $R_{GS}$ =25 $\Omega$
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-
Power dissipation	P <sub>tot</sub>	-	-	69 2.1	W	T <sub>C</sub> =25 °C T <sub>A</sub> =25 °C, R <sub>thJA</sub> =60 K/W <sup>2)</sup>
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56

#### 2 Thermal characteristics

#### Table 3 Thermal characteristics

Darameter	Symbol	Values			l lmi4	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R <sub>thJC</sub>	-	1.1	1.8	K/W	-
Device on PCB, 6 cm <sup>2</sup> cooling area <sup>2)</sup>	R <sub>thJA</sub>	-	-	60	K/W	-

<sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature at 25°C. For higher case temperature please refer to Diagram 2. De-rating will be required based on the actual

environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm2 (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

See Diagram 3 for more detailed information

<sup>&</sup>lt;sup>4)</sup> See Diagram 13 for more detailed information



# 3 Electrical characteristics at $T_j$ =25 °C, unless otherwise specified

Table 4 **Static characteristics** 

_	0		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	100	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	2.2	3.0	3.8	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=36\ \mu {\rm A}$
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1 100	μΑ	V <sub>DS</sub> =100 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =100 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C
Gate-source leakage current	I <sub>GSS</sub>	-	10	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	10.3 8.3	13.0 9.7	mΩ	V <sub>GS</sub> =6 V, I <sub>D</sub> =5 A V <sub>GS</sub> =10 V, I <sub>D</sub> =20 A
Gate resistance <sup>1)</sup>	R <sub>G</sub>	-	1.2	1.8	Ω	-
Transconductance	$g_{fs}$	23	46	-	S	$ V_{DS}  > 2 I_D R_{DS(on)max}, I_D = 20 \text{ A}$

 Table 5
 Dynamic characteristics

Davamatar	Symbol	Values			11::4	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance <sup>1)</sup>	C <sub>iss</sub>	-	1600	2080	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, f=1 MHz
Output capacitance <sup>1)</sup>	Coss	-	250	325	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, f=1 MHz
Reverse transfer capacitance <sup>1)</sup>	C <sub>rss</sub>	-	12	21	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	11	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 $\Omega$
Rise time	t <sub>r</sub>	-	5	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 $\Omega$
Turn-off delay time	$t_{ m d(off)}$	-	21	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 $\Omega$
Fall time	t <sub>f</sub>	-	5	-	ns	$V_{\text{DD}}$ =50 V, $V_{\text{GS}}$ =10 V, $I_{\text{D}}$ =20 A, $R_{\text{G,ext}}$ =3 $\Omega$

Gate charge characteristics<sup>2)</sup> Table 6

Davamatav	S. mahal	Values			11554	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	$Q_{\rm gs}$	-	7	-	nC	$V_{DD}$ =50 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V
Gate charge at threshold	$Q_{g(th)}$	-	4	-	nC	$V_{DD}$ =50 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V
Gate to drain charge <sup>1)</sup>	$Q_{ m gd}$	-	5	8	nC	$V_{DD}$ =50 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V
Switching charge	Q <sub>sw</sub>	-	7	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total <sup>1)</sup>	Qg	-	22	28	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	V <sub>plateau</sub>	-	4.6	-	V	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V
Output charge <sup>1)</sup>	Q <sub>oss</sub>	-	30	40	nC	V <sub>DD</sub> =50 V, V <sub>GS</sub> =0 V
	•	•	•	•		•

Defined by design. Not subject to production test See "Gate charge waveforms" for parameter definition



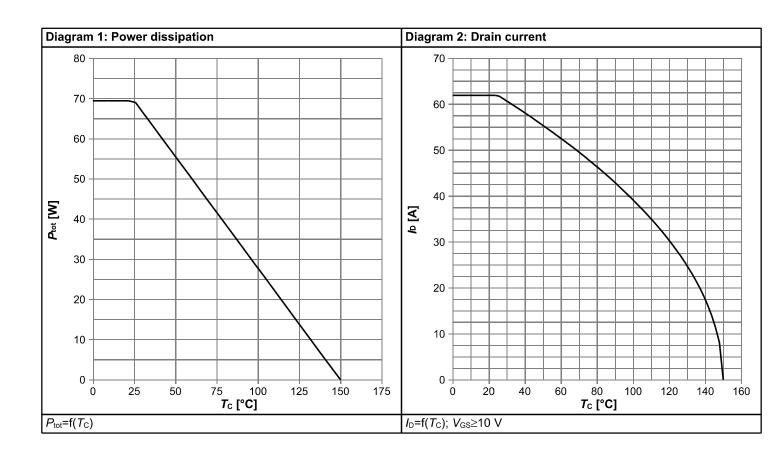
## Table 7 Reverse diode

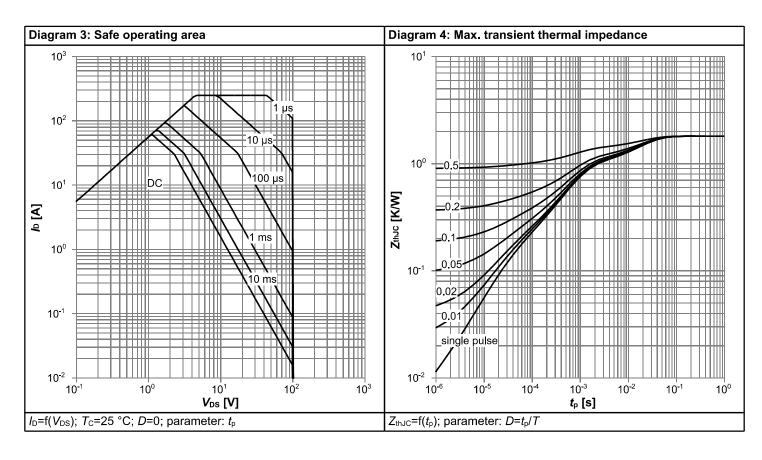
Davamatav	Cumbal	Values			l lmi4	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	48	Α	T <sub>C</sub> =25 °C
Diode pulse current	I <sub>S,pulse</sub>	-	-	248	Α	T <sub>C</sub> =25 °C
Diode forward voltage	e forward voltage $V_{ exttt{SD}}$		0.9	1.2	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =20 A, T <sub>j</sub> =25 °C
Reverse recovery time <sup>1)</sup>	t <sub>rr</sub>	-	43	85	ns	V <sub>R</sub> =50 V, I <sub>F</sub> =20 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs
Reverse recovery charge <sup>1)</sup>	Qrr	-	60	120	nC	V <sub>R</sub> =50 V, I <sub>F</sub> =20 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs

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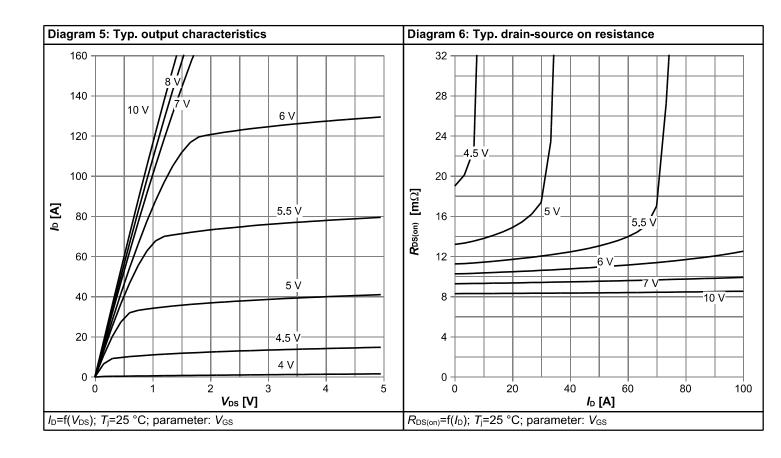


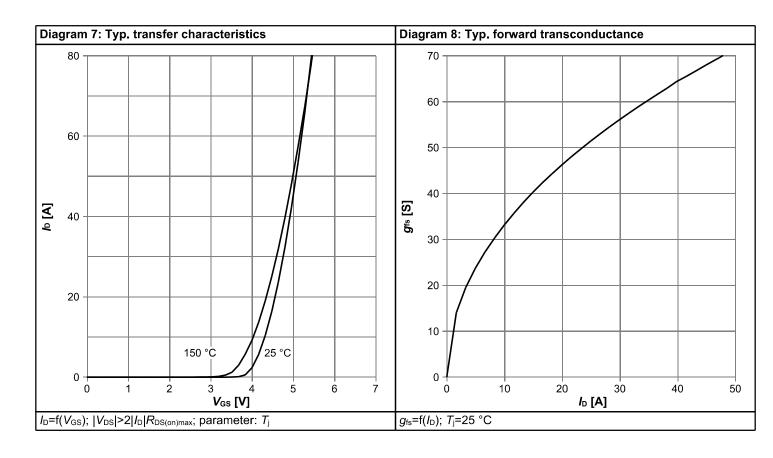
# 4 Electrical characteristics diagrams



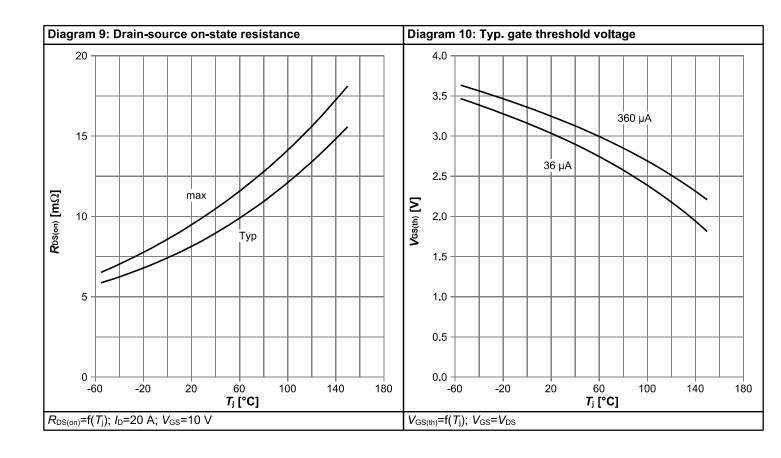


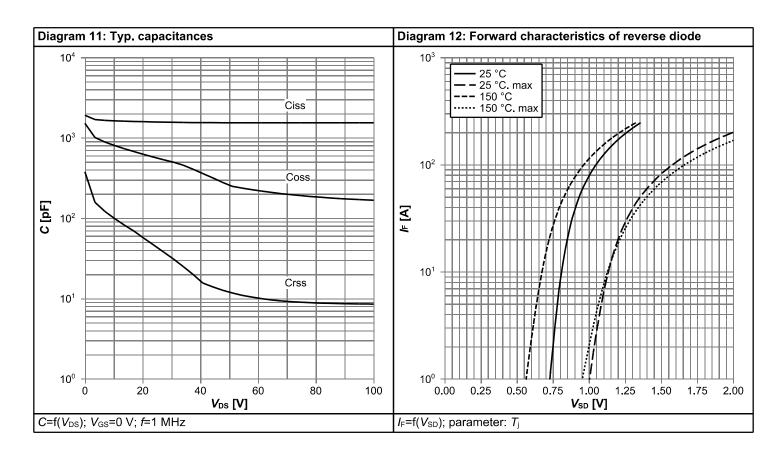




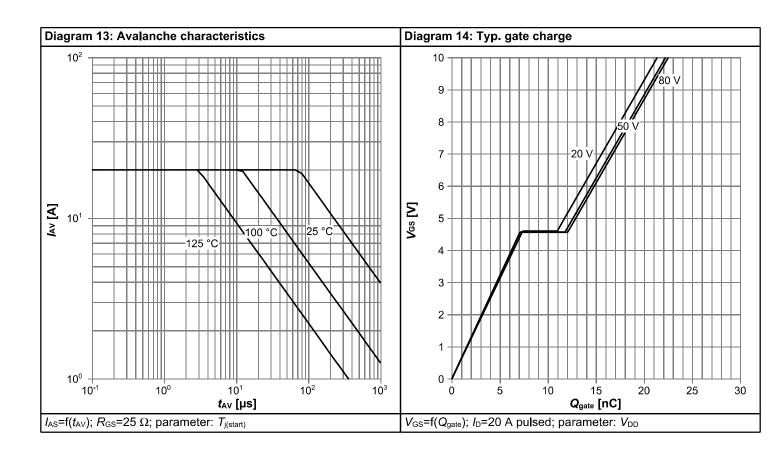


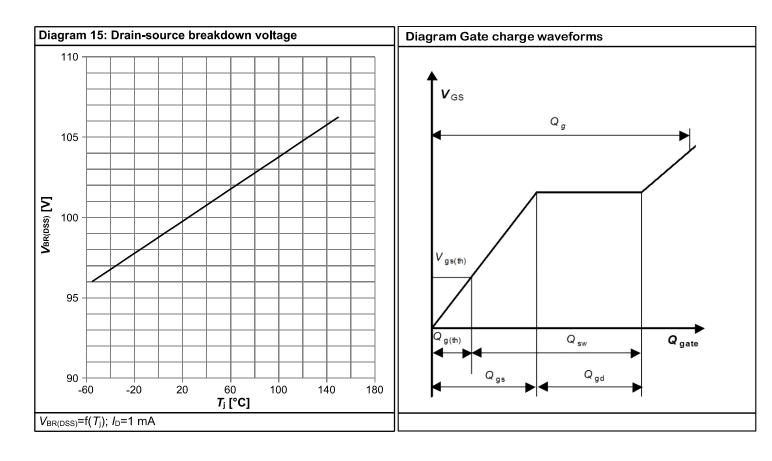






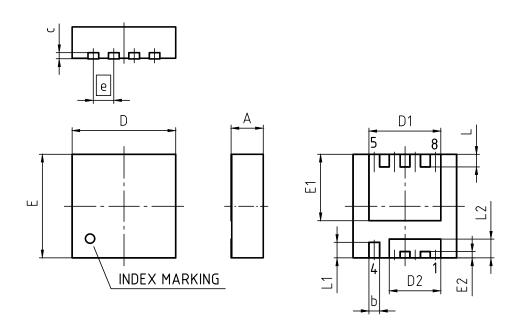








# 5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-TSDS	PG-TSDSON-8-U03				
REVISION: 03	DATE:	20.10.2020				
DIMENSIONS	MILLIM	ETERS				
DIMENSIONS	MIN.	MAX.				
Α	0.90	1.10				
b	0.24	0.44				
С	(0.	20)				
D	3.20	3.40				
D1	2.19	2.39				
D2	1.54	1.74				
E	3.20	3.40				
E1	2.01	2.21				
E2	0.10	0.30				
е	0.0	65				
L	0.30	0.50				
L1	0.40	0.60				
L2	0.50	0.70				
aaa	0.0	)6				

Figure 1 Outline PG-TSDSON-8 FL, dimensions in mm



#### **Revision History**

BSZ097N10NS5

Revision: 2021-06-18, Rev. 2.6

#### Previous Revision

1 101104011	.0 1101011	
Revision	Date	Subjects (major changes since last revision)
2.1	2014-05-05	Release of Final Version
2.2	2016-09-23	Update Avalanche Energy
2.3	2017-01-26	Update Id at Tc=100°C and Ta=25°C
2.4	2020-11-05	Update Max Id Current Rating
2.5	2021-02-09	Update POD
2.6	2021-06-18	Update "Features" and IS

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